

Depletion-Mode Power MOSFET

General Features

- Depletion Mode (Normally On) ۶
- Proprietary Advanced Planar Technology ⊳
- ⊳ Rugged Polysilicon Gate Cell Structure
- ≻ ESD Improved Capability
- ≻ Fast Switching Speed
- **RoHS** Compliant \geq
- \triangleright Halogen-free Available

Applications

- Suppressing Surge Current \triangleright
- Normally-on Switches ⊳
- Constant Current Source \triangleright

Ordering Information

 \triangleright Protection Circuits

	1	N .
	1.6	D

BV_{DSX}

100V

SOT-89

G



SOT-223

RDS(ON) (Max.)

3.0Ω



ID

0.3A

Part Number	Package	Marking	Remark
DMX1072	SOT-89	1072	Halogen Free
DMS1072	SOT-223	1072	Halogen Free

Absolute Maximum Ratings

Absolute I	Maximum Ratings	,	$\Gamma_A=25$ °C unless otherwise	se specified
Symbol	Parameter	DMX1072	DMS1072	Unit
V _{DSX}	Drain-to-Source Voltage ^[1]	10	V	
V _{DGX}	Drain-to-Gate Voltage ^[1]	10	V	
ID	Continuous Drain Current	0.		
I _{DM}	Pulsed Drain Current ^[2]	1.	2	A
D	Power Dissipation	1.0	1.5	W
P_D	Derating Factor above 25°C	0.008	0.012	W/°C
V _{GS}	Gate-to-Source Voltage	±2	V	
$V_{ESD(G\text{-}S)}$	Gate Source ESD IEC, C=150pF, R=330Ω	15	v	
T _L	Soldering Temperature Distance of 1.6mm from case for 10 seconds	30	°C	
$T_{\rm J}$ and $T_{\rm STG}$	Operating and Storage Temperature Range	-55 to		

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.

Thermal Characteristics

Symbol	Parameter	DMX1072	DMS1072	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	125	83	K/W

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DMX1072/DMS1072

OFF Characteristics

Electrical Characteristics

OFF Characteristics						=25°C unless otherwise specified
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
BV _{DSX}	Drain-to-Source Breakdown Voltage	100			V	V _{GS} =-5V, I _D =250µA
				1	μΑ	V_{DS} =100V, V_{GS} =-5V
I _{D(OFF)}	Drain-to-Source Leakage Current			1	mA	V _{DS} =100V, V _{GS} =-5V TJ=125℃
т	Cata ta Cauna Lashara Comunt			20	μA	V_{GS} =+20V, V_{DS} =0V
I _{GSS}	Gate-to-Source Leakage Current			-20		V_{GS} =-20V, V_{DS} =0V

ON Characteristics

 $T_{\rm A}\,{=}25\,^\circ\!{\rm C}$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
I _{DSS}	Saturated Drain-to-Source Current	0.3			А	$V_{GS}=0V, V_{DS}=25V$
D	Static Drain-to-Source On-Resistance			3.0	Ω	V _{GS} =0V, I _D =0.15A ^[3]
R _{DS(ON)}				2.8	Ω	V_{GS} =5V, I_D =0.15A ^[3]
V _{GS(OFF)}	Gate-to-Source Cut-off Voltage	-3.3		-1.5	V	V _{DS} =3V, I _D =8µA
gfs	Forward Transconductance		0.46		S	V _{DS} =20V, I _D =0.15A

Dynamic Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
C _{ISS}	Input Capacitance		81.3		pF	$\begin{array}{c} V_{GS} = -5V\\ V_{DS} = 25V\\ f = 1.0MH_Z \end{array}$
C _{OSS}	Oput Capacitance		32.7			
C _{RSS}	Reverse Transfer Capacitance		6.6			
Q _G	Total Gate Charge		2.52		nC	V _{GS} =-5V~5V V _{DS} =50V, I _D =0.15A
Q _{GS}	Gate-to-Source Charge		0.69			
Q _{GD}	Gate-to-Drain (Miller) Charge		0.7			

Resistive Switching Characteristics

Resistive Switching Characteristics					ntially ind	ependent of operating temperature
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
t _{d(ON)}	Turn-on Delay Time		6.2		ns	$V_{GS}=-5V\sim5V$
t _{rise}	Rise Time		4.8			
t _{d(OFF)}	Turn-off Delay Time		11.6			$\begin{array}{c} V_{DD}{=}50V,I_{D}{=}0.15A\\ R_{G}{=}10\;\Omega \end{array}$
t _{fall}	Fall Time		17			

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Essentially independent of operating temperature



DMX1072/DMS1072

Source-Drain Diode Characteristics

 $T_A=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min	Тур.	Max.	Units	Test Conditions
V _{SD}	Diode Forward Voltage			1.5	V	I _{SD} =0.15A, V _{GS} =-10V
NOTE:						

[1] $T_J=+25^{\circ}C$ to $+150^{\circ}C$

[2] Repetitive rating, pulse width limited by maximum junction temperature. [3] Pulse width \leq 380µs; duty cycle \leq 2%.

DMX1072/DMS1072

Typical Characteristics



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Package Dimensions











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